

ABSTRACT

A circuit board includes at least one prepreg including a fiber layer, the fiber layer being woven with a plurality of first fibers arranged in a first direction and a plurality of
5 second fibers arranged in a second direction that is substantially perpendicular to the first direction, and a circuit layer on at least one of opposite surfaces of the at least one prepreg. The at least one prepreg has a length in the first direction greater than a length in the second
10 direction, each of the plurality of first fibers is formed of or includes a filling yarn, and each of the plurality of second fibers is formed of or includes a warp yarn.

FIG. 5